# NUD3048

# **FET Switch** 100 V, 800 mΩ, N–Channel, TSOP–6

The NUD3048 provides a single device solution for a number of applications requiring a low power, high voltage, FET switch. The package includes a gate resistor and gate to source zener clamp. This switch can accommodate a wide range of input voltages, making it compatible with most current logic levels. Its 100 V rating makes it compatible with 48 V telecom applications.

#### Features

- 100 V Rating On Gate 2
- Integrated 100 k Rg Option
- Integrated ESD Diode Protection
- Low Threshold Voltage
- Pb–Free Package is Available

### **Typical Applications**

- FET Switch
- Inverter
- Level Shifter
- Inrush Limiter
- Relay Driver

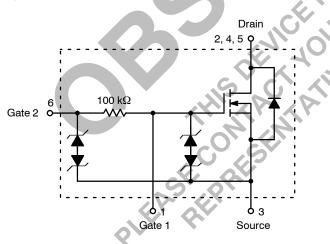
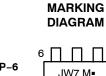


Figure 1. Block Diagram

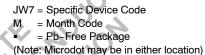


# **ON Semiconductor®**

http://onsemi.com







## ORDERING INFORMATION

| - | Device      | Package             | Shipping <sup>†</sup> |
|---|-------------|---------------------|-----------------------|
|   | NUD3048MT1  | TSOP-6              | 3000 / Tape & Reel    |
|   | NUD3048MT1G | TSOP-6<br>(Pb-Free) | 3000 / Tape & Reel    |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **MAXIMUM RATINGS**

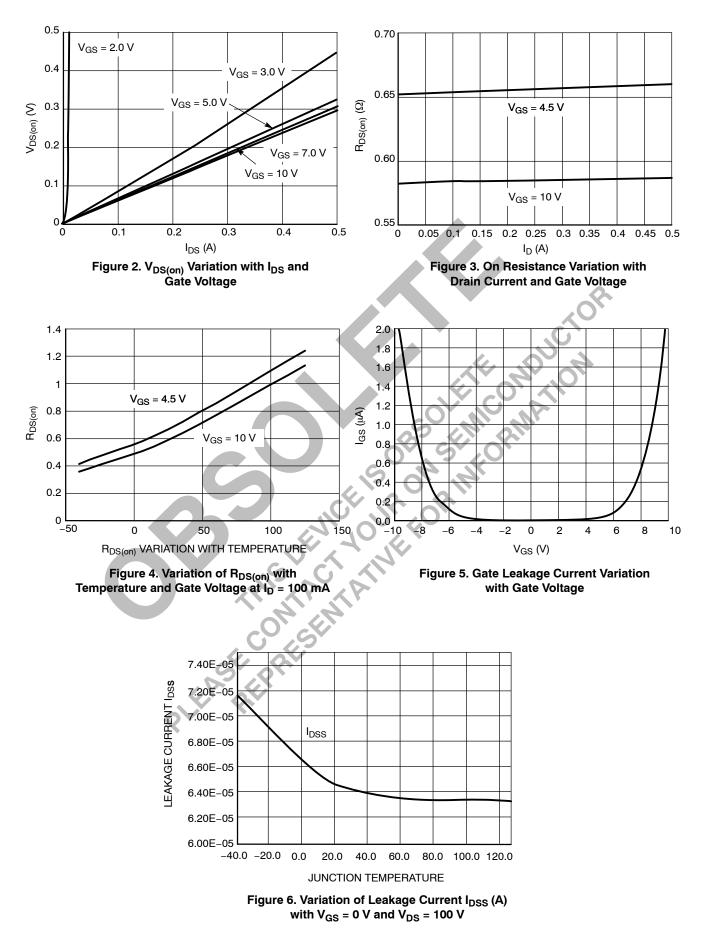
| Symbol            | Rating  | Value        | Unit   |
|-------------------|---|--------------|--------|
| V <sub>DSS</sub>  | Drain to Source Voltage – Continuous  | 100          | V      |
| V <sub>G1SS</sub> | Gate to Source Voltage – Continuous @ 1.0 mA  | 15           | V      |
| ۱ <sub>D</sub>    | Drain Current – Continuous (T <sub>A</sub> =25°C) (Note 1)<br>(Note 2)                                | 0.7<br>1.2   | A      |
| PD                | Power Dissipation ( $T_A = 25^{\circ}C$ ) (Note 1)<br>(Note 2)  | 0.66<br>1.56 | W      |
| V <sub>G2SS</sub> | Gate Resistor to Source Voltage – Continuous  | 100          | V      |
| T <sub>Jmax</sub> | Maximum Junction Temperature  | 150          | °C     |
| $R_{\thetaJA}$    | Thermal Impedance (Junction-to-Ambient) (Note 1)<br>Thermal Impedance (Junction-to-Ambient) (Note 2)  | 190<br>80    | °C/W   |
| ESD               | Human Body Model (HBM) Class 2<br>Machine Model Class A<br>According to EIA/JESD22/A114 Specification | 2000<br>160  | V<br>V |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

| Characteristic   | Symbol              | Min | Тур        | Max      | Unit |
|--|---------------------|-----|------------|----------|------|
| OFF CHARACTERISTICS  |                     |     | .0.        |          |      |
| Drain to Source Leakage Current ( $V_{DS}$ = 80 V, $V_{GS}$ = 0 V)   | IDSS                |     | 20         | 100      | μA   |
| Gate Body Leakage Current<br>( $V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V}$ )<br>( $V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V}, T_J = 125^{\circ}\text{C}$ ) | I <sub>GSS</sub>    |     | 3.0<br>6.0 | 10<br>20 | μΑ   |
| ON CHARACTERISTICS   |                     | 2   |            |          | •    |
| Gate Threshold Voltage (I <sub>D</sub> = 1.0 mA)   | V <sub>GS</sub>     | 1.3 | 1.7        | 2.0      | V    |
| Drain to Source Resistance ( $V_{GS}$ = 4.5 V, $I_D$ = 100 mA)   | R <sub>DS(on)</sub> | -   | 0.65       | 0.82     | Ω    |
| Drain to Source Resistance (V <sub>GS</sub> = 10 V, I <sub>D</sub> = 100 mA)   | R <sub>DS(on)</sub> | -   | 0.6        | 0.72     | Ω    |
| DYNAMIC CHARACTERISTICS  | $\sim$              |     |            |          | •    |
| Input Capacitance ( $V_{DS}$ = 5.0 V, $V_{GS}$ = 0 V, f = 10 kHz)  | C <sub>iss</sub>    | -   | 135        | -        | pF   |
| Output Capacitance ( $V_{DS}$ = 5.0 V, $V_{GS}$ = 0 V, f = 10 kHz)   | C <sub>oss</sub>    | -   | 75         | -        | pF   |
| Transfer Capacitance ( $V_{DS}$ = 5.0 V, $V_{GS}$ = 0 V, f = 10 kHz)   | C <sub>rss</sub>    | -   | 26         | -        | pF   |
| GATE BIAS CHARACTERISTICS  |                     |     |            |          |      |
| Gate Resistor  | R <sub>G</sub>      | 75  | 100        | 125      | kΩ   |
| Gate Zener Breakdown Voltage (Iz = 1.0 mA) (Note 3)  | Vz                  | 15  | 17         | -        | V    |
| Gate Zener Breakdown Voltage (Iz = 3.0 mA) (Note 4)  |                     | 100 | 115        | -        |      |

Min pad, 1 oz. Cu.
1 inch pad, 1 oz Cu.
Measured from gate 1 to source.
Measured from gate 2 to source.

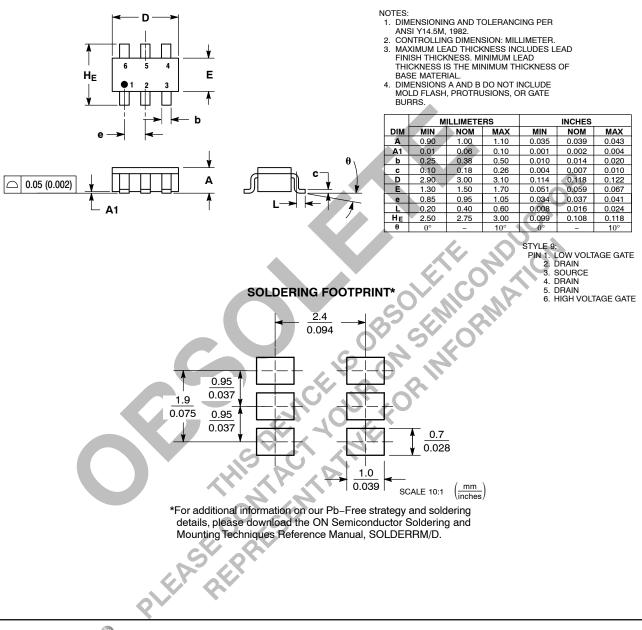
## NUD3048



### NUD3048

#### PACKAGE DIMENSIONS

TSOP-6 CASE 318G-02 ISSUE P



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